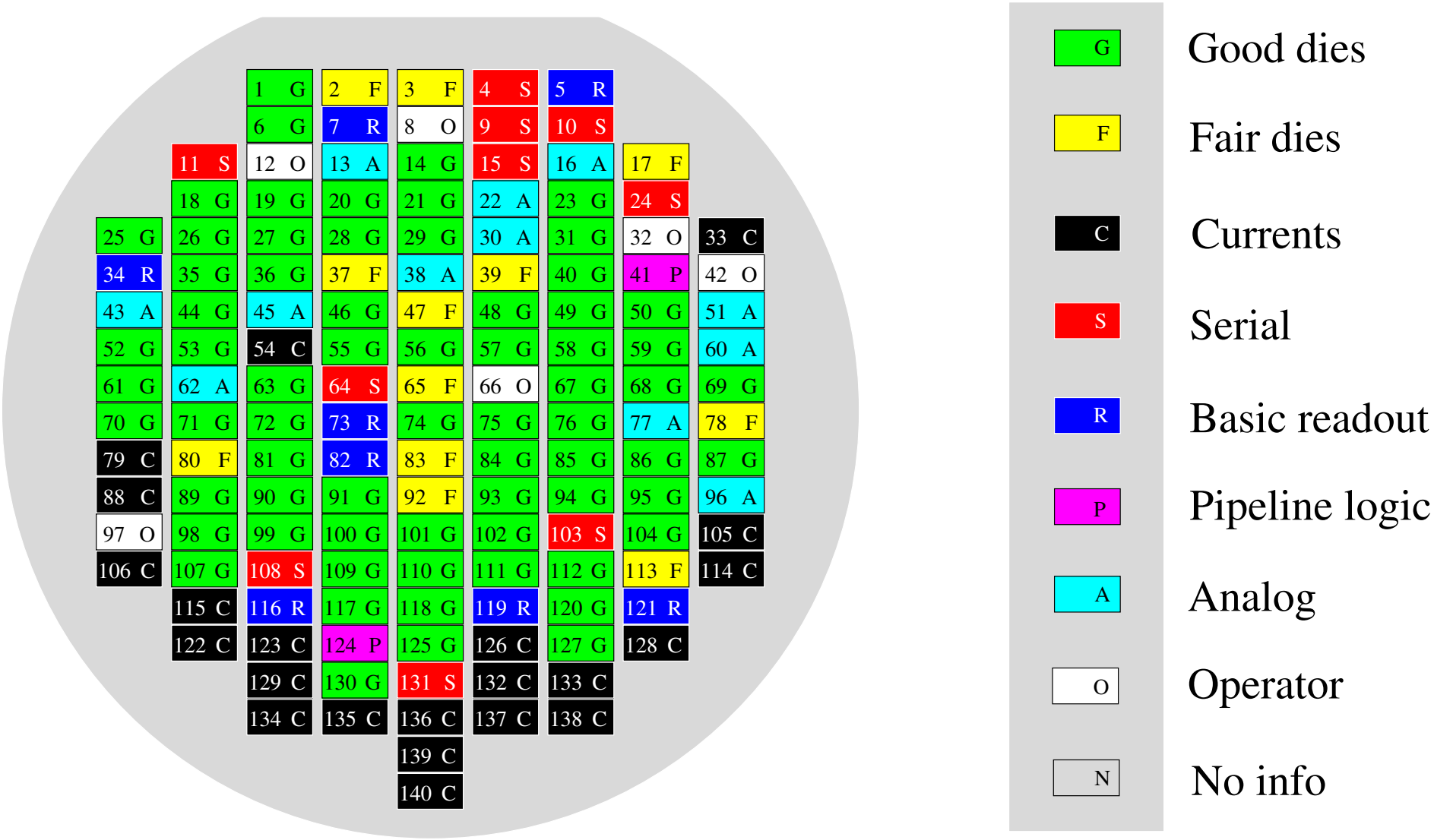
Types of die failures for wafer 153 s/n: Y21316-08-08

Date: 06/16/99